

**High Performance RF Transceiver/Transmitter for
Narrowband Systems**

ERRATA NOTE

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1 VCO Calibration

1.1 Description

The RF frequency is set by the on-chip inductor, a capacitor array and a varactor. There is a finite possibility that the calibration fails because a non-optimum index to the capacitor array is chosen during the calibration. When the calibration fails the chip will always use a too low index for the capacitor array (i.e. too high capacitance).

1.2 Suggested Workaround

For CC1120, CC1121, CC1125, and CC1175 with PARTVERSION register equal to 0x21, two manual calibrations must be performed as shown in the flow diagram in Figure 1. The SW implementation is shown in Figure 2.

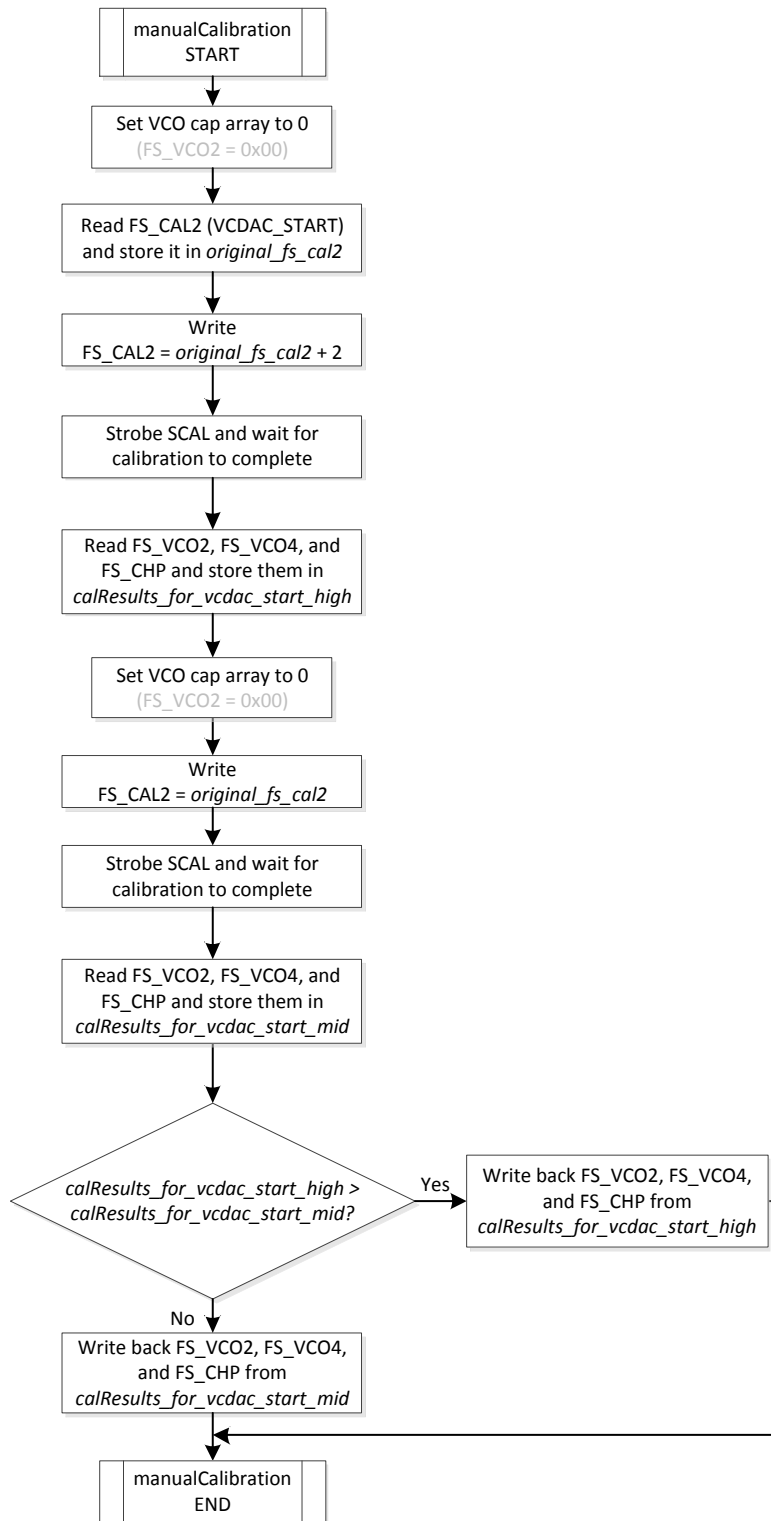


Figure 1. Flow Diagram

```

#define VCDAC_START_OFFSET 2
#define FS_VCO2_INDEX 0
#define FS_VCO4_INDEX 1
#define FS_CHP_INDEX 2

void manualCalibration(void) {

    uint8 original_fs_cal2;
    uint8 calResults_for_vcdac_start_high[3];
    uint8 calResults_for_vcdac_start_mid[3];
    uint8 marcstate;
    uint8 writeByte;

    // 1) Set VCO cap-array to 0 (FS_VCO2 = 0x00)
    writeByte = 0x00;
    cc112xSpiWriteReg(CC112X_FS_VCO2, &writeByte, 1);

    // 2) Start with high VCDAC (original VCDAC_START + 2):
    cc112xSpiReadReg(CC112X_FS_CAL2, &original_fs_cal2, 1);
    writeByte = original_fs_cal2 + VCDAC_START_OFFSET;
    cc112xSpiWriteReg(CC112X_FS_CAL2, &writeByte, 1);

    // 3) Calibrate and wait for calibration to be done (radio back in IDLE state)
    trxSpiCmdStrobe(SCAL);
    do {
        cc112xSpiReadReg(CC112X_MARCSTATE, &marcstate, 1);
    } while (marcstate != 0x41);

    // 4) Read FS_VCO2, FS_VCO4 and FS_CHP register obtained with high VCDAC START value
    cc112xSpiReadReg(CC112X_FS_VCO2, &calResults_for_vcdac_start_high[FS_VCO2_INDEX], 1);
    cc112xSpiReadReg(CC112X_FS_VCO4, &calResults_for_vcdac_start_high[FS_VCO4_INDEX], 1);
    cc112xSpiReadReg(CC112X_FS_CHP, &calResults_for_vcdac_start_high[FS_CHP_INDEX], 1);

    // 5) Set VCO cap-array to 0 (FS_VCO2 = 0x00)
    writeByte = 0x00;
    cc112xSpiWriteReg(CC112X_FS_VCO2, &writeByte, 1);

    // 6) Continue with mid VCDAC (original VCDAC_START):
    writeByte = original_fs_cal2;
    cc112xSpiWriteReg(CC112X_FS_CAL2, &writeByte, 1);

    // 7) Calibrate and wait for calibration to be done (radio back in IDLE state)
    trxSpiCmdStrobe(SCAL);
    do {
        cc112xSpiReadReg(CC112X_MARCSTATE, &marcstate, 1);
    } while (marcstate != 0x41);

    // 8) Read FS_VCO2, FS_VCO4 and FS_CHP register obtained with mid VCDAC START value
    cc112xSpiReadReg(CC112X_FS_VCO2, &calResults_for_vcdac_start_mid[FS_VCO2_INDEX], 1);
    cc112xSpiReadReg(CC112X_FS_VCO4, &calResults_for_vcdac_start_mid[FS_VCO4_INDEX], 1);
    cc112xSpiReadReg(CC112X_FS_CHP, &calResults_for_vcdac_start_mid[FS_CHP_INDEX], 1);

    // 9) Write back highest FS_VCO2 and corresponding FS_VCO and FS_CHP result
    if (calResults_for_vcdac_start_high[FS_VCO2_INDEX] > calResults_for_vcdac_start_mid[FS_VCO2_INDEX]) {
        writeByte = calResults_for_vcdac_start_high[FS_VCO2_INDEX];
        cc112xSpiWriteReg(CC112X_FS_VCO2, &writeByte, 1);
        writeByte = calResults_for_vcdac_start_high[FS_VCO4_INDEX];
        cc112xSpiWriteReg(CC112X_FS_VCO4, &writeByte, 1);
        writeByte = calResults_for_vcdac_start_high[FS_CHP_INDEX];
        cc112xSpiWriteReg(CC112X_FS_CHP, &writeByte, 1);
    }
    else {
        writeByte = calResults_for_vcdac_start_mid[FS_VCO2_INDEX];
        cc112xSpiWriteReg(CC112X_FS_VCO2, &writeByte, 1);
        writeByte = calResults_for_vcdac_start_mid[FS_VCO4_INDEX];
        cc112xSpiWriteReg(CC112X_FS_VCO4, &writeByte, 1);
        writeByte = calResults_for_vcdac_start_mid[FS_CHP_INDEX];
        cc112xSpiWriteReg(CC112X_FS_CHP, &writeByte, 1);
    }
}

```

Figure 2. SW Implementation

2 General Information

2.1 Document History

Revision	Date	Description/Changes
SWRZ039	2011-06-29	Initial release
SWRZ039A	2012-04-30	Added CC1125 and CC1175

Table 1: Document History

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